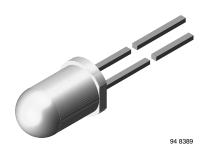
TSHG6400



Vishay Semiconductors

High Speed Infrared Emitting Diode, 850 nm, GaAlAs Double Hetero



FEATURES

- · Package type: leaded
- Package form: T-1³⁄₄
- Dimensions (in mm): Ø 5
- Peak wavelength: $\lambda_p = 850 \text{ nm}$
- High reliability
- · High radiant power
- · High radiant intensity
- Angle of half intensity: $\varphi = \pm 22^{\circ}$
- Low forward voltage
- Suitable for high pulse current operation
- High modulation bandwidth: f_c = 18 MHz
- · Good spectral matching with CMOS cameras
- Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC

Note

** Please see document "Vishay Material Category Policy": <u>www.vishay.com/doc?99902</u>

APPLICATIONS

- Infrared radiation source for operation with CMOS cameras (illumination).
- High speed IR data transmission.

DESCRIPTION

TSHG6400 is an infrared, 850 nm emitting diode in GaAlAs double hetero (DH) technology with high radiant power and high speed, molded in a clear, untinted plastic package.

| PRODUCT SUMMARY | | | | | |
|-----------------|------------------------|----------------|---------------------|---------------------|--|
| COMPONENT | l _e (mW/sr) | φ (deg) | λ _p (nm) | t _r (ns) | |
| TSHG6400 | 70 | ± 22 | 850 | 20 | |

Note

Test conditions see table "Basic Characteristics"

| ORDERING INFORMATION | | | | |
|-------------------------|------|------------------------------|--------------|--|
| ORDERING CODE PACKAGING | | REMARKS | PACKAGE FORM | |
| TSHG6400 | Bulk | MOQ: 4000 pcs, 4000 pcs/bulk | T-1¾ | |

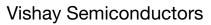
Note

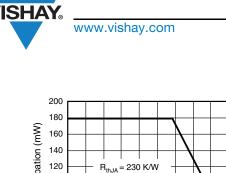
MOQ: minimum order quantity

| ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified) | | | | |
|--|--|-------------------|---------------|------|
| PARAMETER | TEST CONDITION | SYMBOL | VALUE | UNIT |
| Reverse voltage | | V _R | 5 | V |
| Forward current | | I _F | 100 | mA |
| Peak forward current | $t_p/T = 0.5, t_p = 100 \ \mu s$ | I _{FM} | 200 | mA |
| Surge forward current | t _p = 100 μs | I _{FSM} | 1 | A |
| Power dissipation | | Pv | 180 | mW |
| Junction temperature | | Тj | 100 | °C |
| Operating temperature range | | T _{amb} | - 40 to + 85 | °C |
| Storage temperature range | | T _{stg} | - 40 to + 100 | °C |
| Soldering temperature | $t \le 5$ s, 2 mm from case | T _{sd} | 260 | °C |
| Thermal resistance junction/ambient | J-STD-051, leads 7 mm soldered on PCB | R _{thJA} | 230 | K/W |

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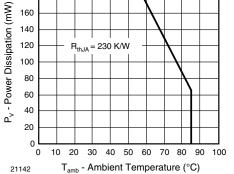


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

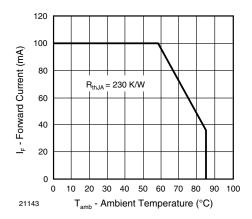


Fig. 2 - Forward Current Limit vs. Ambient Temperature

| BASIC CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified) | | | | | | |
|---|---|------------------|------|--------|------|-------|
| PARAMETER | TEST CONDITION | SYMBOL | MIN. | TYP. | MAX. | UNIT |
| Forward voltage | I _F = 100 mA, t _p = 20 ms | V _F | | 1.5 | 1.8 | V |
| | I _F = 1 A, t _p = 100 μs | V _F | | 2.3 | | V |
| Temperature coefficient of V_F | I _F = 1 mA | TK _{VF} | | - 1.8 | | mV/K |
| Reverse current | V _R = 5 V | I _R | | | 10 | μA |
| Junction capacitance | $V_{R} = 0 V, f = 1 MHz, E = 0$ | Cj | | 125 | | pF |
| Radiant intensity | I _F = 100 mA, t _p = 20 ms | l _e | 45 | 70 | 135 | mW/sr |
| | I _F = 1 A, t _p = 100 μs | l _e | | 700 | | mW/sr |
| Radiant power | I _F = 100 mA, t _p = 20 ms | φ _e | | 50 | | mW |
| Temperature coefficient of ϕ_{e} | I _F = 100 mA | TKφ _e | | - 0.35 | | %/K |
| Angle of half intensity | | φ | | ± 22 | | deg |
| Peak wavelength | I _F = 100 mA | λρ | | 850 | | nm |
| Spectral bandwidth | I _F = 100 mA | Δλ | | 40 | | nm |
| Temperature coefficient of λ_p | I _F = 100 mA | ΤΚλρ | | 0.25 | | nm/K |
| Rise time | I _F = 100 mA | t _r | | 20 | | ns |
| Fall time | I _F = 100 mA | t _f | | 13 | | ns |
| Cut-off frequency | $I_{DC} = 70$ mA, $I_{AC} = 30$ mA pp | f _c | | 18 | | MHz |
| Virtual source diameter | | d | | 3.7 | | mm |



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BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

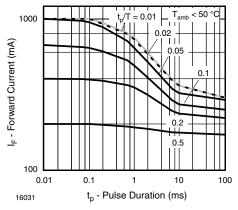


Fig. 3 - Pulse Forward Current vs. Pulse Duration

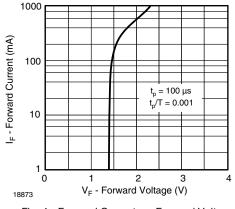


Fig. 4 - Forward Current vs. Forward Voltage

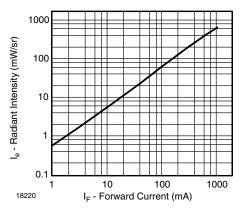


Fig. 5 - Radiant Intensity vs. Forward Current

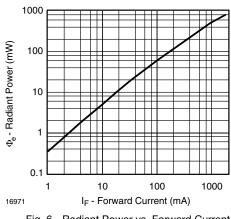
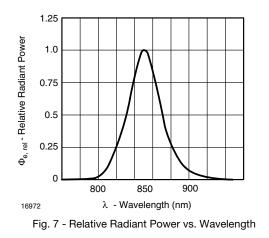


Fig. 6 - Radiant Power vs. Forward Current



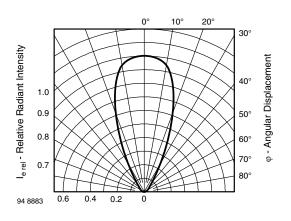


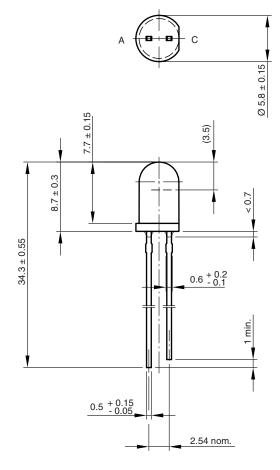
Fig. 8 - Relative Radiant Intensity vs. Angular Displacement

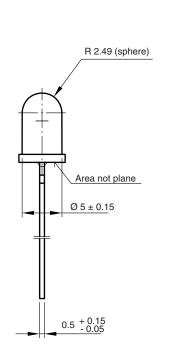
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PACKAGE DIMENSIONS in millimeters







technical drawings according to DIN specifications

Drawing-No.: 6.544-5259.06-4 Issue: 6; 19.05.09 19257



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